



SMD Disk Varistors

Series/Type: V10K175

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B72210M0171K000		2025-10-31	2026-02-13	2026-05-15
B72210M0171K001		2025-10-31	2026-02-13	2026-05-15
B72210M0211K000		2025-10-31	2026-02-13	2026-05-15



Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B72210M0211K001		2025-10-31	2026-02-13	2026-05-15
B72210M0231K000		2025-10-31	2026-02-13	2026-05-15
B72210M0231K001		2025-10-31	2026-02-13	2026-05-15
B72210M0251K000		2025-10-31	2026-02-13	2026-05-15
B72210M0251K001		2025-10-31	2026-02-13	2026-05-15
B72210M0271K000		2025-10-31	2026-02-13	2026-05-15
B72210M0271K001		2025-10-31	2026-02-13	2026-05-15
B72210M0301K000		2025-10-31	2026-02-13	2026-05-15
B72210M0301K001		2025-10-31	2026-02-13	2026-05-15
B72210M0321K000		2025-10-31	2026-02-13	2026-05-15
B72210M0321K001		2025-10-31	2026-02-13	2026-05-15
B72210M0351K000		2025-10-31	2026-02-13	2026-05-15
B72210M0351K001		2025-10-31	2026-02-13	2026-05-15
B72210M0381K000		2025-10-31	2026-02-13	2026-05-15
B72210M0381K001		2025-10-31	2026-02-13	2026-05-15
B72210M0421K000		2025-10-31	2026-02-13	2026-05-15
B72210M0421K001		2025-10-31	2026-02-13	2026-05-15
B72210M0461K000		2025-10-31	2026-02-13	2026-05-15
B72210M0461K001		2025-10-31	2026-02-13	2026-05-15

Please contact your nearest TDK sales office if you need support in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.tdk-electronics.tdk.com/sales.

Features

- Suitable for surface mount device assembly
- AEC-Q200-Rev E qualified
- Optional for vertical version or horizontal version


Applications

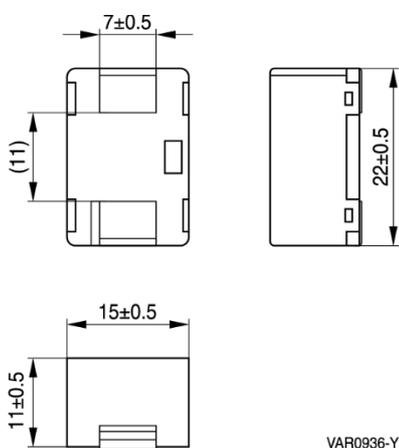
Overvoltage protection, especially on-board chargers

SIOV nomenclature

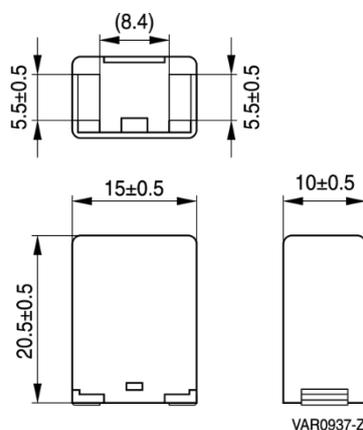
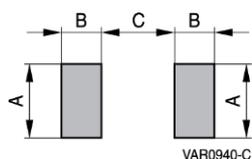
V(H)	Vertical version or horizontal version
10	Rated disk dimension
K	Tolerance of V_V at 1 mA: $\pm 10\%$
175 – 460	Max. AC operating voltage
*	Optional, typical design of customer

Dimensional drawings in mm

Horizontal version



Vertical version


Recommended solder pad layout in mm


Type	A	B	C
V10K*	8.5	5.3	6.4
H10K*	10.0	7.5	9.0

Electrical specifications and ordering codes

 Maximum ratings ($T_A = 125\text{ °C}$)

Type	Ordering code	V_{RMS} V	V_{DC} V
V10K175	<u>B72210M0171K000</u>	175	225
H10K175	<u>B72210M0171K001</u>	175	225
V10K210	<u>B72210M0211K000</u>	210	270
H10K210	<u>B72210M0211K001</u>	210	270
V10K230	<u>B72210M0231K000</u>	230	300
H10K230	<u>B72210M0231K001</u>	230	300
V10K250	<u>B72210M0251K000</u>	250	320
H10K250	<u>B72210M0251K001</u>	250	320
V10K275	<u>B72210M0271K000</u>	275	350
H10K275	<u>B72210M0271K001</u>	275	350
V10K300	<u>B72210M0301K000</u>	300	385
H10K300	<u>B72210M0301K001</u>	300	385
V10K320	<u>B72210M0321K000</u>	320	420
H10K320	<u>B72210M0321K001</u>	320	420
V10K350	<u>B72210M0351K000</u>	350	460
H10K350	<u>B72210M0351K001</u>	350	460
V10K385	<u>B72210M0381K000</u>	385	505
H10K385	<u>B72210M0381K001</u>	385	505
V10K420	<u>B72210M0421K000</u>	420	560
H10K420	<u>B72210M0421K001</u>	420	560
V10K460	<u>B72210M0461K000</u>	460	615
H10K460	<u>B72210M0461K001</u>	460	615

Characteristics ($T_A = 25\text{ °C}$)

Type	I_{\max} (8/20 μs) 1 time A	I_n ¹⁾ (8/20 μs) 15 times A	W_{\max} (2 ms) J	P_{\max} W	V_v (1 mA) V $\pm 10\%$	$V_{c,\max}$ ($i_c=35\text{A}$) V	C_{typ} (1 kHz) pF
V10K175	6000	3000	80.0	0.60	270	455	670
H10K175	6000	3000	80.0	0.60	270	455	670
V10K210	6000	3000	95.0	0.60	330	545	620
H10K210	6000	3000	95.0	0.60	330	545	620
V10K230	6000	3000	105.0	0.60	360	595	580
H10K230	6000	3000	105.0	0.60	360	595	580
V10K250	6000	3000	115.0	0.60	390	650	550
H10K250	6000	3000	115.0	0.60	390	650	550
V10K275	6000	3000	130.0	0.60	430	710	510
H10K275	6000	3000	130.0	0.60	430	710	510
V10K300	6000	3000	140.0	0.60	470	775	475
H10K300	6000	3000	140.0	0.60	470	775	475
V10K320	6000	3000	150.0	0.60	510	840	425
H10K320	6000	3000	150.0	0.60	510	840	425
V10K350	6000	3000	165.0	0.60	560	910	380
H10K350	6000	3000	165.0	0.60	560	910	380
V10K385	6000	3000	180.0	0.60	620	1025	330
H10K385	6000	3000	180.0	0.60	620	1025	330
V10K420	6000	3000	190.0	0.60	680	1120	280
H10K420	6000	3000	190.0	0.60	680	1120	280
V10K460	6000	3000	200.0	0.60	750	1240	245
H10K460	6000	3000	200.0	0.60	750	1240	245

¹⁾ **Note:** Nominal discharge current I_n according to UL 1449, 4th edition.

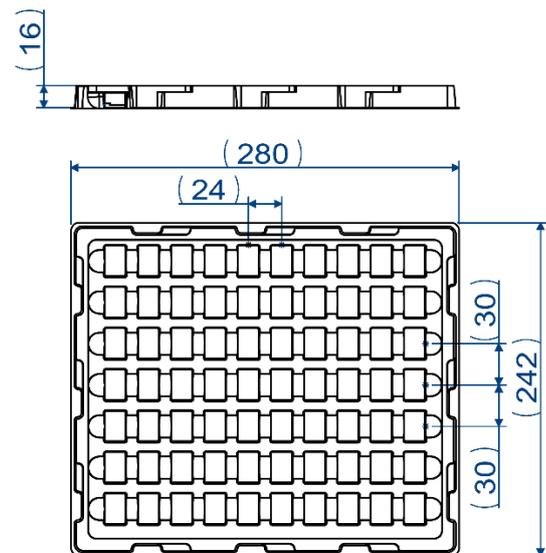
General technical data

Climatic category	to IEC 60068-1	40/125/56
Operating temperature	to IEC 61051	-40 ... +125 °C
Storage temperature		-40 ... +150 °C
Electric strength	to IEC 61051	$\geq 2.5\text{ kV}_{\text{RMS}}$
Insulation resistance	to IEC 61051	$\geq 100\text{ M}\Omega$

Packaging

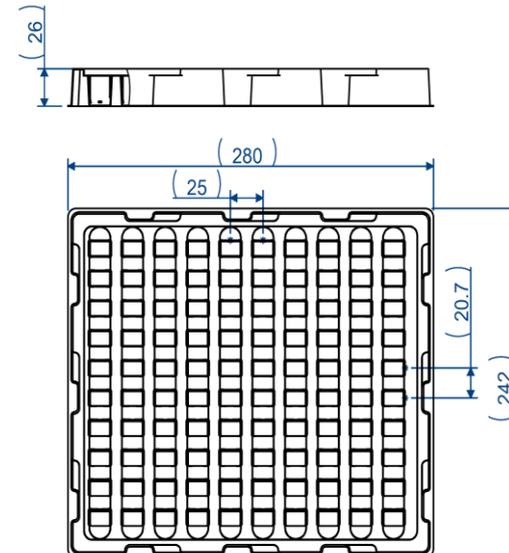
Horizontal version

- Standard packaging is in trays
- Quantity per tray: 70 pcs
- Quantity per box: 210 pcs



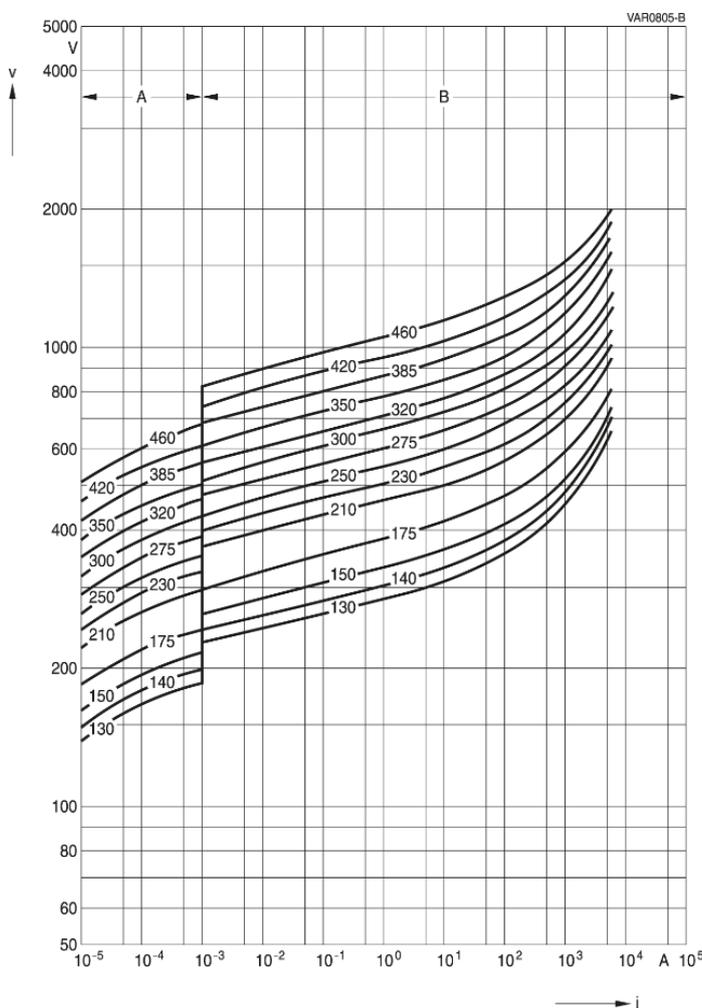
Vertical version

- Standard packaging is in trays
- Quantity per tray: 100 pcs
- Quantity per box: 200 pcs

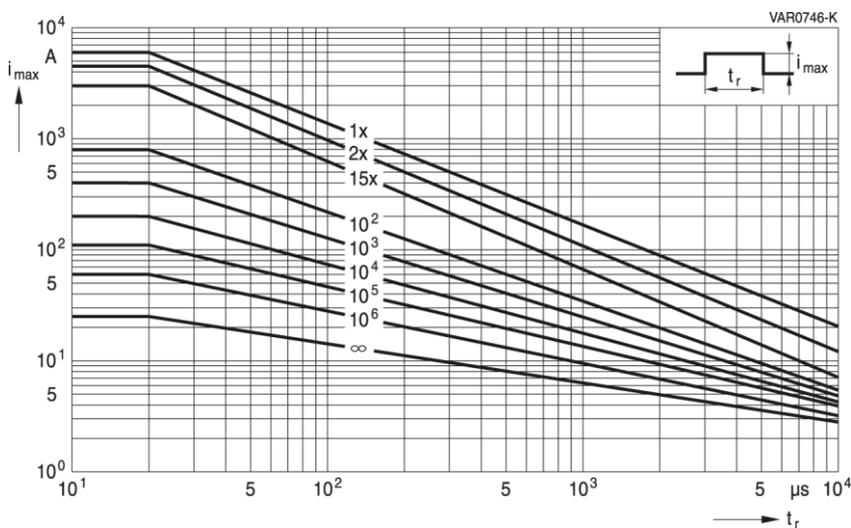


() means reference dimensions
Unit: mm

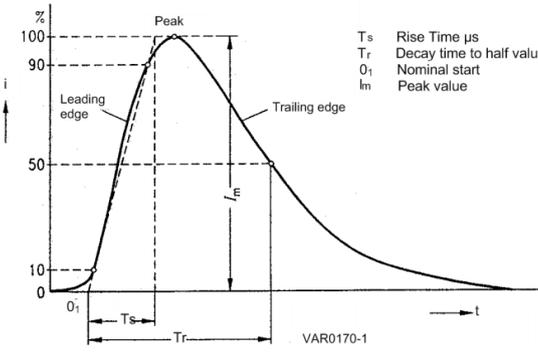
V/I characteristics



Derating curves



Electrical reliability data

Characteristics	Test methods/description	Specifications
Varistor voltage	The voltage between two terminals with the specified measuring current applied is called V_V (1 mA _{DC} @ 0.2 ... 2 s).	To meet the specified value
Clamping voltage	The maximum voltage between two terminals with the specified standard impulse current (8/20 μ s) illustrated below applied. <div style="text-align: center;">  </div>	To meet the specified value
Surge current derating, 8/20 μ s	10 surge currents (8/20 μ s), unipolar, interval 30 s, amplitude corresponding to derating curve for 10 impulses at 20 μ s	$ \Delta V / V (1 \text{ mA}) \leq 10\%$ (measured in direction of surge current) No visible damage
Surge current derating, 2 ms	10 surge currents (2 ms), unipolar, interval 120 s, amplitude corresponding to derating curve for 10 impulses at 2 ms	$ \Delta V / V (1 \text{ mA}) \leq 10\%$ (measured in direction of surge current) No visible damage

Mechanical reliability data

Characteristics	Test methods/description	Specifications
Vibration	AEC-Q200-Rev E MIL-STD-202 method 204 5 g for 20 min., 12 cycles each of 3 orientations Test from 10 to 2000 Hz	$ \Delta V / V (1 \text{ mA}) \leq 5\%$ No visible damage
Mechanical shock	AEC-Q200-Rev E MIL-STD-202 Method 213 Figure 1 of Method 213 Condition C	$ \Delta V / V (1 \text{ mA}) \leq 5\%$ No visible damage
Solderability	IEC 60068-2-58, test Td1, method 1 Solder bath, Sn96.5Ag3Cu0.5 $T = 245 \pm 3 \text{ }^\circ\text{C}$ $t = 2 \text{ s}$	The terminations shall be uniformly tinned for soldering test.
Resistance to soldering heat	IEC60068-2-58, test Td2, method 1 Solder bath, Sn96.5Ag3Cu0.5 $T = 260 \pm 5 \text{ }^\circ\text{C}$ $D = 10 \pm 1 \text{ s}$	$ \Delta V / V (1 \text{ mA}) \leq 5\%$ No visible damage
Board flex	AEC-Q200-Rev E 005 60 seconds minimum holding time	$ \Delta V / V (1 \text{ mA}) \leq 5\%$ No visible damage
Electric strength	IEC 61051-1, test 4.9.2 Metal balls method, 2500 VRMS, 60 s The varistor is placed in a container holding 1.6 \pm 0.2 mm diameter metal balls such that only the terminations of the varistor are protruding. The specified voltage shall be applied between both terminals of the specimen connected together and the electrode inserted between the metal balls.	No breakdown

Environmental reliability data

Characteristics	Test methods/description	Specifications
Max. DC operating voltage	MIL-STD-202F, method 108A, UCT, V_{DC} , 1000 h	$ \Delta V / V (1 \text{ mA}) \leq 10\%$ No visible damage
Damp heat, steady state	IEC 60068-2-67, test Cy, 85 °C, 85% RH, $0.85 * V_V (1 \text{ mA})$, 1000 h	$ \Delta V / V (1 \text{ mA}) \leq 10\%$ No visible damage
Climatic sequence	<p>The specimen shall be subjected to:</p> <p>a) IEC 60068-2-2, test Ba, dry heat at UCT, 16 h</p> <p>b) IEC 60068-2-30, test Db, damp heat, 1st cycle: 55 °C, 93% RH, 24 h</p> <p>c) IEC 60068-2-1, test Aa, cold, LCT, 2 h</p> <p>d) IEC 60068-2-30, test Db, damp heat, additional 5 cycles: 55 °C/25 °C, 93% RH, 24 h/cycle.</p> <p>Then the specimen shall be stored at room temperature and normal humidity for 1 to 2 h. Thereafter, the change of V_V shall be measured. Thereafter, insulation resistance R_{ins} shall be measured at $V = 500 \text{ V}$.</p>	$ \Delta V / V (1 \text{ mA}) \leq 10\%$ $R_{ins} \geq 100 \text{ M}\Omega$
Rapid change of temperature	IEC 60068-2-14, test Na, LCT/UCT, dwell time 10 min., 1000 cycles	$ \Delta V / V (1 \text{ mA}) \leq 5\%$ No visible damage

Note:

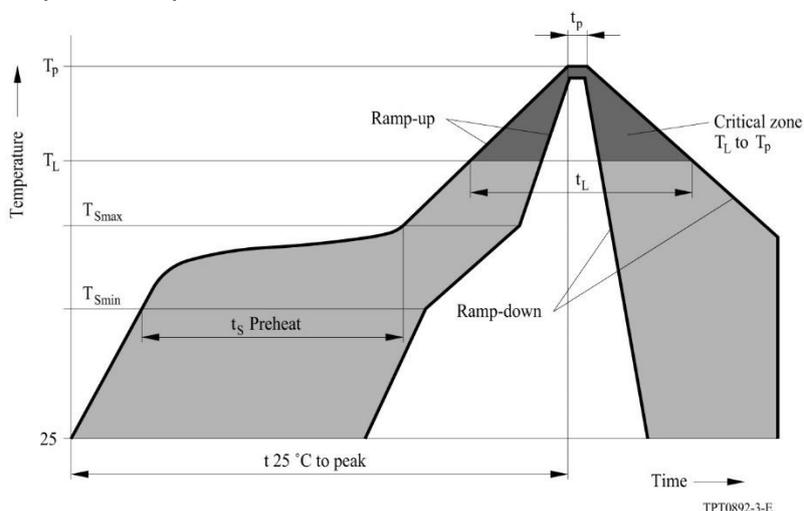
UCT = Upper category temperature

LCT = Lower category temperature

R_{ins} = Insulation resistance

Recommended soldering temperature profiles

Reflow soldering temperature profile



Profile feature	Sn-Pb eutectic assembly	Pb-free assembly
Average ramp-up rate (T_{Smax} to T_P)	3 K/s max	3 K/s max
Preheat <ul style="list-style-type: none"> ▪ Minimum temperature (T_{Smin}) ▪ Maximum temperature (T_{Smax}) ▪ Time (t_{Smin} to t_{Smax}) 	100 °C 150 °C 60 ... 120 s	150 °C 200 °C 60...180 s
Time maintained above <ul style="list-style-type: none"> ▪ Minimum temperature (T_L) ▪ Time (t_L) 	183 °C 60 ... 150 s	217 °C 60 ... 150 s
Peak classification temperature (T_P)	220 °C ... 240 °C	240 °C ... 260 °C
Time within 5 °C of actual peak temperature (t_p)	10 ... 30 s	20 ... 40 s
Ramp-down rate	6 K/s max	6 K/s max
Time 25 °C to peak temperature	6 min. max	8 min. max

Note: All temperatures refer to the topside of the package, measured on the package body surface.
Maximum number of reflow cycles: 3

Soldering guidelines

The usage of mild, non-activated fluxes for soldering is recommended, as well as proper cleaning of the PCB.

Cautions and warnings

General

1. TDK Electronics' metal oxide varistors (SIOVs) are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with TDK Electronics during the design-in phase.
2. Ensure suitability of SIOVs through reliability testing during the design-in phase. The SIOVs should be evaluated taking into consideration worst-case conditions.
3. For applications of SIOVs in line-to-ground circuits based on various international and local standards restrictions exist or additional safety measures are required.

Storage

1. Store SIOVs only in original packaging. Do not open the package prior to processing.
2. Recommended storage conditions in original packaging:
 - Storage temperature: -25 °C ... +45 °C
 - Relative humidity: < 75% annual average, < 95% on maximum 30 days a year
 - Dew precipitation is to be avoided.
3. Avoid contamination of the SIOVs during storage, handling, and processing.
4. Avoid storage of SIOVs in harmful environments that can affect the function during long-term operation (examples given under operation precautions).
5. The SIOV type series should be soldered after shipment from TDK Electronics within the time specified:
 - SIOV-S, -Q, -LS, -B, -SNF: 24 months
 - ETFV/ T series, -CU: 12 months

Handling

1. SIOVs must not be dropped.
2. Components must not be touched with bare hands. Gloves are recommended.
3. Avoid contamination of the surface of SIOV electrodes during handling, be careful of the sharp edge of the SIOV's electrodes.

Soldering (where applicable)

1. Use rosin-type flux or non-activated flux.
2. Insufficient preheating may cause ceramic cracks.
3. Rapid cooling by dipping in solvent is not recommended.
4. Complete removal of flux is recommended.
5. Temperatures of all preheat stages and the solder bath must be strictly controlled especially for T series (T14 and T20).

Mounting

1. Potting, sealing or adhesive compounds can produce chemical reactions in the SIOV ceramic that will degrade the component's electrical characteristics.
2. Overloading SIOVs may result in ruptured packages and expulsion of hot materials. For this reason, the SIOVs should be physically shielded from adjacent components.

Operation

1. Use SIOVs only within the specified temperature operating range
2. Use SIOVs only within the specified voltage and current ranges.
3. Environmental conditions must not harm the SIOVs. Use SIOVs only in normal atmospheric conditions. Avoid use in the presence of deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas, etc.), corrosive agents, humid or salty conditions. Avoid contact with any liquids and solvents.

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The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.** Detailed information can be found on the Internet at www.tdk-electronics.tdk.com/orderingcodes.

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The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.

We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

6. Unless otherwise agreed in individual contracts, **all orders are subject to our General Terms and Conditions of Supply**.
7. **Our manufacturing sites serving the automotive business apply the IATF 16949 standard**. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System**. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.

Important notes

8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, FilterCap, FormFit, InsuGate, LeaXield, MediPlas, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PiezoBrush, PlasmaBrush, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SurfIND, ThermoFuse, WindCap, XieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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